

# 1.5A, 50V - 1000V High Efficient Surface Mount Rectifier

#### **FEATURES**

- Glass passivated chip junction
- Ideal for automated placement
- Low profile package
- Fast switching for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- DC to DC converter
- Switching mode converters and inverters
- Lighting application
- Snubber
- · Freewheeling application

#### **MECHANICAL DATA**

- Case: DO-214AC (SMA)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.060g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I <sub>F</sub>	1.5	Α		
$V_{RRM}$	50 - 1000	V		
I <sub>FSM</sub>	50	Α		
T <sub>J MAX</sub>	150	°C		
Package	DO-214AC (SMA)			
Configuration	Single die			









DO-214AC (SMA)



PARAMETER	SYMBOL	HS	_	HS 2DA	HS 2FA	HS 2GA	HS 2JA	HS 2KA	HS 2MA	UNIT
		2AA								
Marking code on the device		HS 2AA	HS 2BA	HS 2DA	HS 2FA	HS 2GA	HS 2JA	HS 2KA	HS 2MA	
Repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	200	300	400	600	800	1000	V
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	35	70	140	210	280	420	560	700	V
Forward current	I <sub>F</sub>	1.5			Α					
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	50				А				
Junction temperature	TJ	- 55 to +150			°C					
Storage temperature	T <sub>STG</sub>	- 55 to +150			°C					

1



THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	80	°C/W	

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
(1)	HS2AA HS2BA HS2DA HS2FA	I <sub>F</sub> = 1.5A, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	1.0	V
Forward voltage <sup>(1)</sup>	HS2GA			-	1.3	V
	HS2JA HS2KA HS2MA			-	1.7	V
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>		T <sub>J</sub> = 25°C		-	5	μΑ
		T <sub>J</sub> = 125°C	- I <sub>R</sub>	-	100	μΑ
Junction capacitance	HS2AA HS2BA HS2DA HS2FA HS2GA	1MHz, V <sub>R</sub> = 4.0V	C <sub>J</sub>	50	-	pF
	HS2JA HS2KA HS2MA			30	-	pF
Reverse recovery time	HS2AA HS2BA HS2DA HS2FA HS2GA	$I_F = 0.5A, I_R = 1.0A,$ $I_{rr} = 0.25A$	t <sub>rr</sub>	-	50	ns
	HS2JA HS2KA HS2MA	]		-	75	ns

### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING		
HS2xA	DO-214AC (SMA)	7,500 / Tape & Reel		

### Notes:

1. "x" defines voltage from 50V(HS2AA) to 1000V(HS2MA)



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

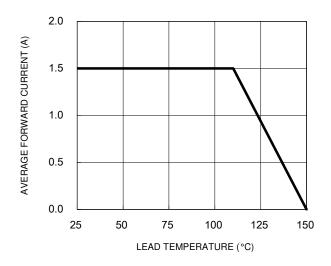


Fig.3 Typical Reverse Characteristics

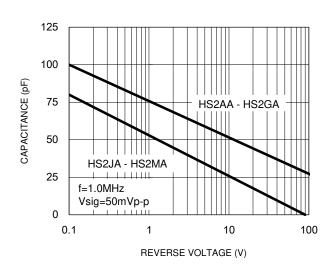
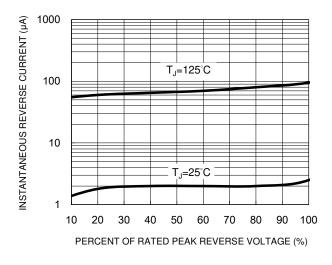


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



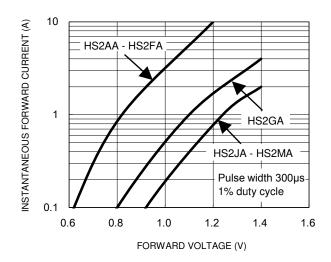
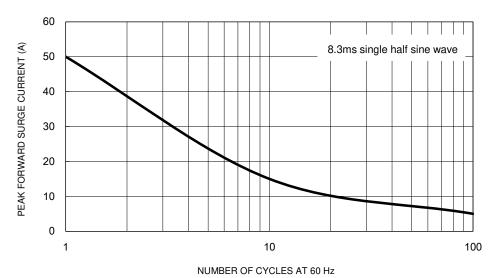


Fig.5 Maximum Non-Repetitive Forward Surge Current



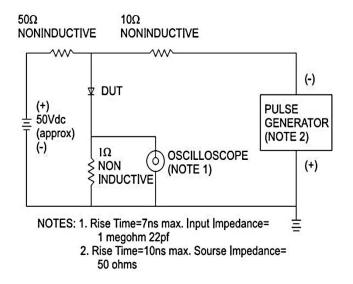
3

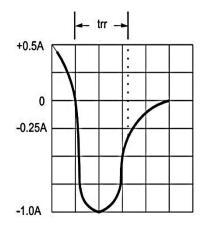


### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram



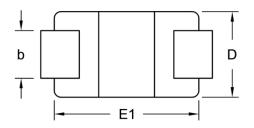


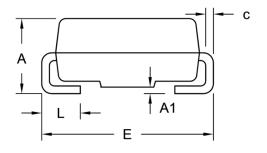




## **PACKAGE OUTLINE DIMENSIONS**

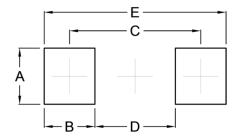
# DO-214AC (SMA)





DIM.	Unit (mm)		Unit (	inch)	
Dilvi.	Min.	Max.	Min.	Max.	
Α	1.99	2.50	0.078	0.098	
A1	0.10	0.20	0.004	0.008	
b	1.27	1.58	0.050	0.062	
С	0.15	0.31	0.006	0.012	
D	2.29	2.83	0.090	0.111	
E	4.95	5.33	0.195	0.210	
E1	4.06	4.60	0.160	0.181	
L	0.90	1.41	0.035	0.056	

### **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
E	5.45	0.215

# **MARKING DIAGRAM**



= Marking Code P/N G = Green Compound

= Date Code ΥW F = Factory Code



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